



Descriptions

Double N-CHANNEL MOSFET in a SOT-363 Plastic Package.

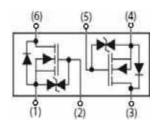
Features

Sensitive gate trigger current and Low Holding current.ESD protected diode. ESD rating:2200V HBM

Applications

Intended for use in general purpose switching and phase control applications.

Equivalent Circuit



Pinning



PIN1、4:S PIN 2、5:G PIN 3、6:D

2018-10/33 REV:D

Absolute Maximum Ratings(Ta=25 °C)

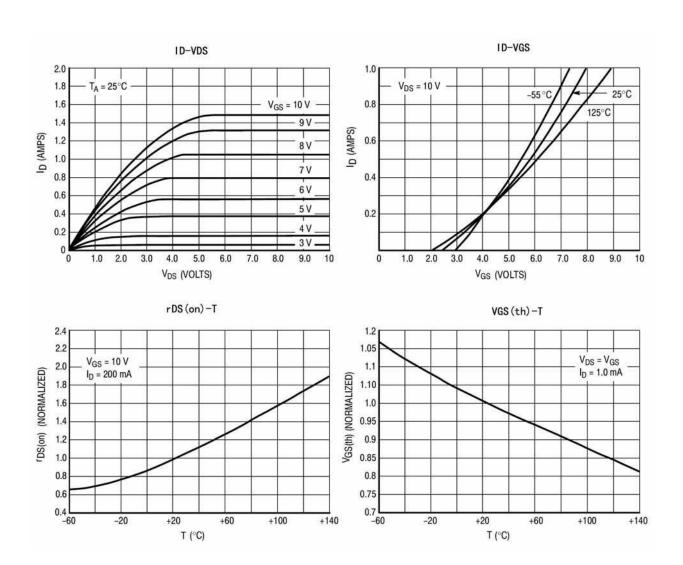
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	60	V
Drain-Gate Voltage	V_{DGR}	60	V
Maximum Drain Current - Continuous	I _D	250	mA
Maximum Drain Current - Pulsed	I _{DM}	800	mA
Gate-Source Voltage - Continuous	V _{GSS}	±20	V
Maximum Power Dissipation	P _D	350	mW
Storage Temperature Range	T _{stg}	- 55∼150	$^{\circ}$

Electrical Characteristics(Ta=25 °C)

Doromotor	Symbol	T4 O		N 45	Tun		11.14
Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0	I _D =10μA	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} =0 T _j =25℃	V _{DS} =60V			1.0	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} =0 T _j =125℃	V _{DS} =60V			500	μΑ
Gate - Body Leakage	I _{GSS}	V _{GS} =±20V	V _{DS} =0V			±10	nA
Static Drain-Source On-Resistance	R _{DS(on)(1)}	V _{GS} =5V	I _D =0.05A		1.5	5	Ω
	R _{DS(on)(2)}	V _{GS} =10V	$I_D = 0.5A$		1.3	5	Ω
Forward Transconductance	g FS	V _{DS} =10V	I _D =0.2A	80			mS
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V	I _S =250mA			1.5	V
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS}	I _D =250μA	1.0		1.9	V
On-State Drain Current	I _{D(on)}	V _{DS} ≥2.0V _{DS} V _{GS} =10V	(on)	500			mA
	$V_{DS(on)(1)}$	V _{GS} =10V	$I_D=500mA$			2.5	V
Drain-Source On-Voltage	V _{DS(on)(2)}	V _{GS} =5.0V	I _D =50mA			0.27 5	V
Turn-On Time	t _{d(on)}	V _{DD} =30V	D 050		7.5	20	ns
Turn-Off Time	t _{d(off)}	I_D =200mA R_L =150 Ω	R_G =25Ω V_{gen} =10V		11	20	ns

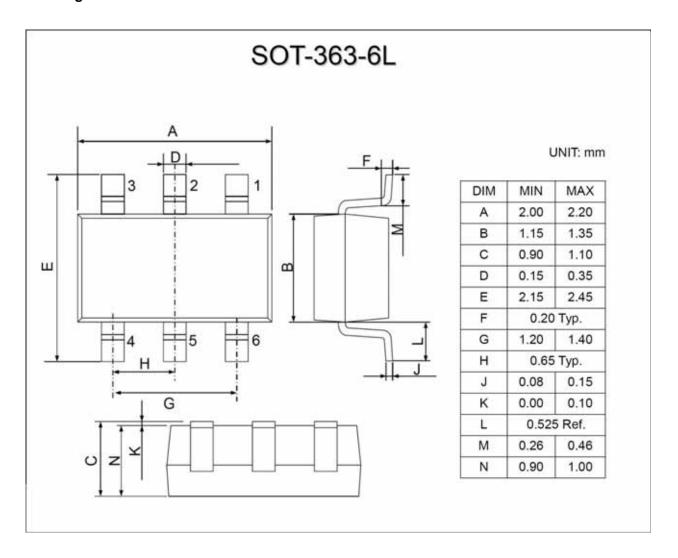


RATING AND CHARACTERISTICS CURVES (2N7002KS6)

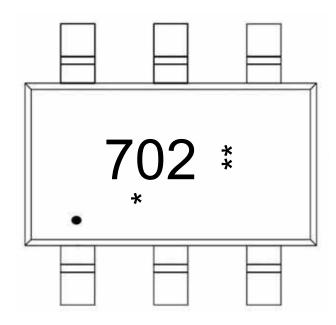




Package Dimensions



Marking Instructions



Note:

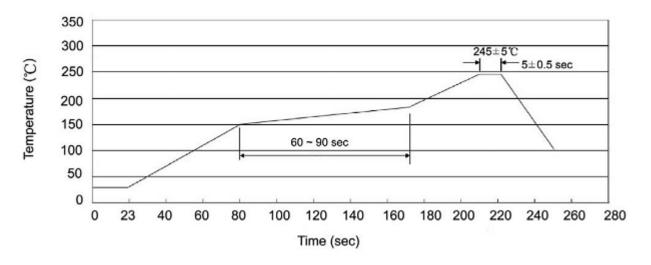
• : "1" Pin

702 : Product Type Code

***: Lot No. Code, code change with Lot No.



Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

1.Preheating:25~150 °C, Time:60~90sec.

 $2. Peak\ Temp.: 245\pm5^{\circ}C,\ Duration: 5\pm0.5 sec.$

3.Cooling Speed: 2~10°C/sec.

Resistance to Soldering Heat Test Conditions

Temp.:260±5 ℃ Time:10±1 sec

Packaging SPEC.

Package Type	Units				Dimension		(unit: mm ³)	
r donago Typo	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT-363	3,000	10	30,000	8	240,000	7″ ×8	180×120×180	385×257×392



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